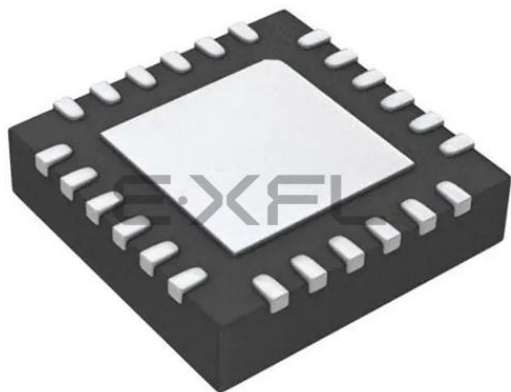




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Details

Product Status	Active
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SMBus (2-Wire/I ² C), SPI, UART/USART
Peripherals	POR, PWM, Temp Sensor, WDT
Number of I/O	21
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	768 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 16x10b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	24-WFQFN Exposed Pad
Supplier Device Package	24-QFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f338-gm

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3. Pin Definitions**Table 3.1. Pin Definitions for the C8051F336/7/8/9**

Name	Pin 'F336/7	Pin 'F338/9	Type	Description
V _{DD}	3	4		Power Supply Voltage.
GND	2	3		Ground. This ground connection is required. The center pad may optionally be connected to ground also.
RST/ C2CK	4	5	D I/O D I/O	Device Reset. Open-drain output of internal POR or V _{DD} monitor. An external source can initiate a system reset by driving this pin low for at least 10 μ s. Clock signal for the C2 Debug Interface.
C2D	5	6	D I/O	Bi-directional data signal for the C2 Debug Interface. Shared with P2.0 on 20-pin packaging and P2.4 on 24-pin packaging.
P0.0/ VREF	1	2	D I/O or A In A In	Port 0.0. External VREF input.
P0.1 IDA0	20	1	D I/O or A In A Out	Port 0.1. IDA0 Output.
P0.2/ XTAL1	19	24	D I/O or A In A In	Port 0.2. External Clock Input. This pin is the external oscillator return for a crystal or resonator.
P0.3/ XTAL2	18	23	D I/O or A In A I/O or D In	Port 0.3. External Clock Output. For an external crystal or resonator, this pin is the excitation driver. This pin is the external clock input for CMOS, capacitor, or RC oscillator configurations.
P0.4	17	22	D I/O or A In	Port 0.4.
P0.5	16	21	D I/O or A In	Port 0.5.
P0.6/ CNVSTR	15	20	D I/O or A In D In	Port 0.6. ADC0 External Convert Start or IDA0 Update Source Input.

5. QFN-24 Package Specifications

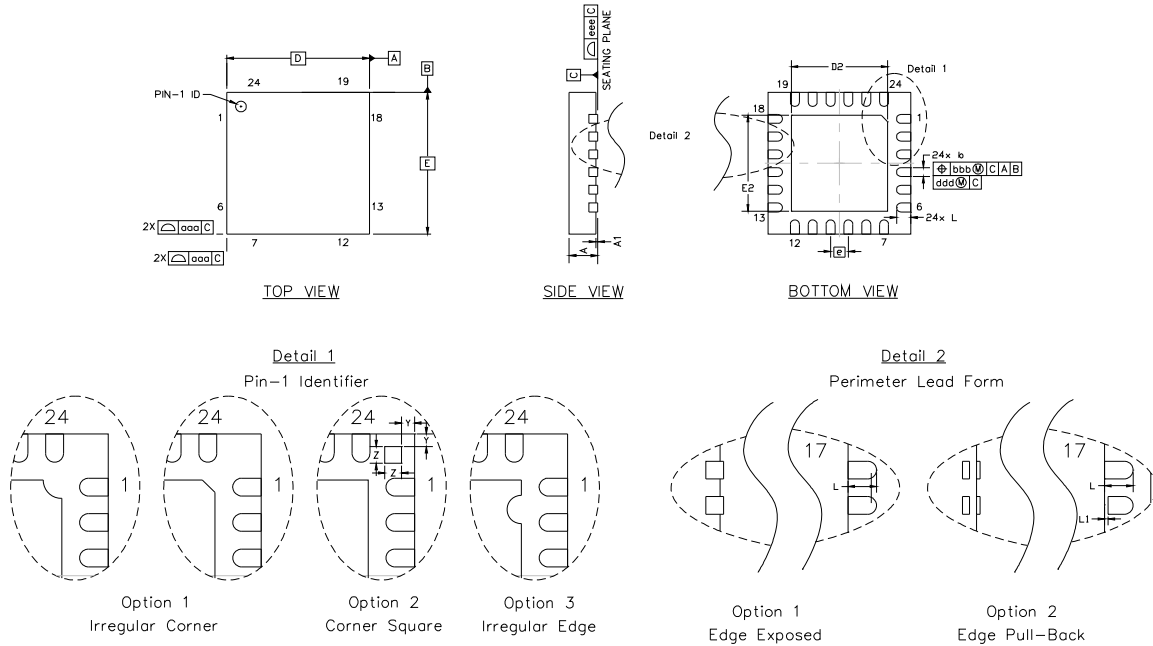


Figure 5.1. QFN-24 Package Drawing

Table 5.1. QFN-24 Package Dimensions

Dimension	Min	Typ	Max
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
b	0.18	0.25	0.30
D	4.00 BSC.		
D2	2.55	2.70	2.80
e	0.50 BSC.		
E	4.00 BSC.		
E2	2.55	2.70	2.80

Dimension	Min	Typ	Max
L	0.30	0.40	0.50
L1	0.00	—	0.15
aaa	—	—	0.15
bbb	—	—	0.10
ddd	—	—	0.05
eee	—	—	0.08
Z	—	0.24	—
Y	—	0.18	—

Notes:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to JEDEC Solid State Outline MO-220, variation WGGD except for custom features D2, E2, Z, Y, and L which are toleranced per supplier designation.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

7.3.1. Window Detector In Single-Ended Mode

Figure 7.4 shows two example window comparisons for right-justified, single-ended data, with $ADC0LTH:ADC0LTL = 0x0080$ (128d) and $ADC0GTH:ADC0GTL = 0x0040$ (64d). In single-ended mode, the input voltage can range from '0' to $VREF \times (1023/1024)$ with respect to GND, and is represented by a 10-bit unsigned integer value. In the left example, an $AD0WINT$ interrupt will be generated if the $ADC0$ conversion word ($ADC0H:ADC0L$) is within the range defined by $ADC0GTH:ADC0GTL$ and $ADC0LTH:ADC0LTL$ (if $0x0040 < ADC0H:ADC0L < 0x0080$). In the right example, an $AD0WINT$ interrupt will be generated if the $ADC0$ conversion word is outside of the range defined by the $ADC0GT$ and $ADC0LT$ registers (if $ADC0H:ADC0L < 0x0040$ or $ADC0H:ADC0L > 0x0080$). Figure 7.5 shows an example using left-justified data with the same comparison values.

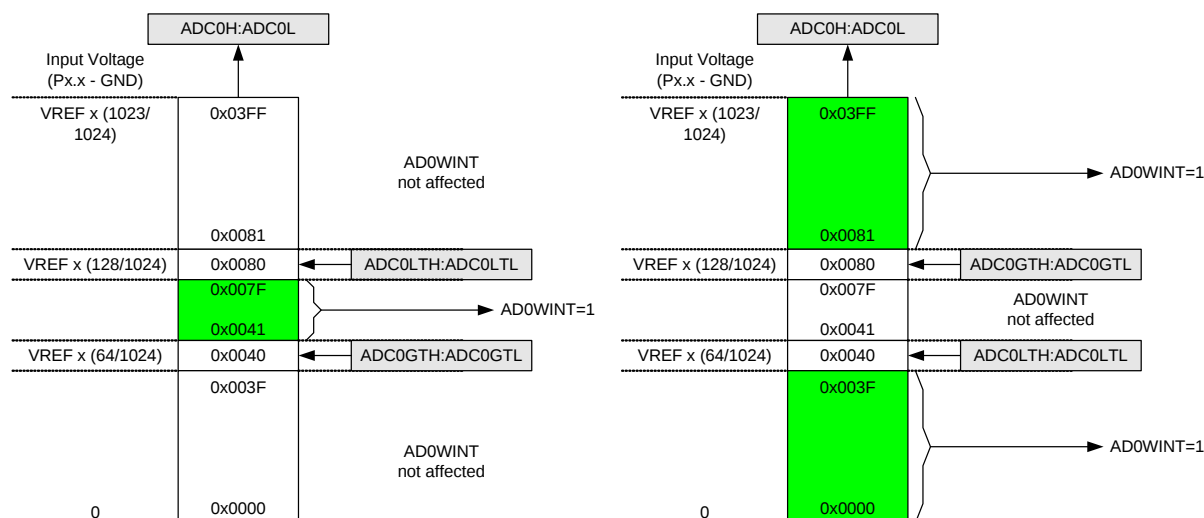


Figure 7.4. ADC Window Compare Example: Right-Justified Single-Ended Data

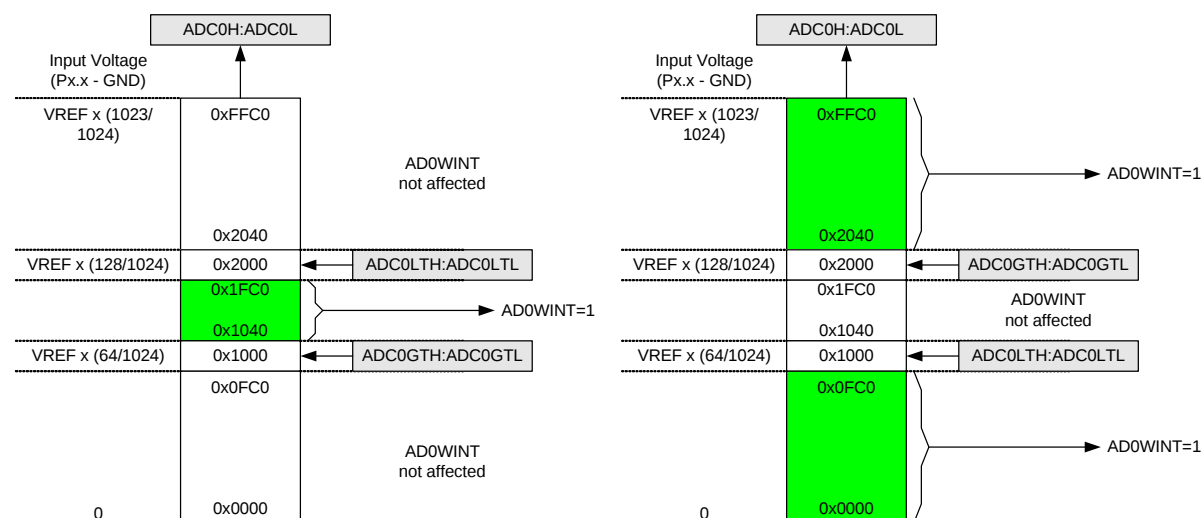


Figure 7.5. ADC Window Compare Example: Left-Justified Single-Ended Data

C8051F336/7/8/9

SFR Definition 7.9. AMX0P: AMUX0 Positive Channel Select

Bit	7	6	5	4	3	2	1	0
Name				AMX0P[4:0]				
Type	R	R	R	R/W				
Reset	0	0	0	1	1	1	1	1

SFR Address = 0xBB

Bit	Name	Function
7:5	UNUSED	Unused. Read = 000b; Write = Don't Care.
4:0	AMX0P[4:0]	AMUX0 Positive Input Selection. 00000: P0.0 00001: P0.1 00010: P0.2 00011: P0.3 00100: P0.4 00101: P0.5 00110: P0.6 00111: P0.7 01000: P1.0 01001: P1.1 01010: P1.2 01011: P1.3 01100: P1.4 01101: P1.5 01110: P1.6 01111: P1.7 10000: Temp Sensor 10001: V_{DD} 10010: P2.0 (C8051F338/9 Only) 10011: P2.1 (C8051F338/9 Only) 10100: P2.2 (C8051F338/9 Only) 10101: P2.3 (C8051F338/9 Only) 10110 – 11111: no input selected

SFR Definition 11.1. CPT0CN: Comparator0 Control

Bit	7	6	5	4	3	2	1	0
Name	CP0EN	CP0OUT	CP0RIF	CP0FIF	CP0HYP[1:0]		CP0HYN[1:0]	
Type	R/W	R	R/W	R/W	R/W		R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x9B

Bit	Name	Function
7	CP0EN	Comparator0 Enable Bit. 0: Comparator0 Disabled. 1: Comparator0 Enabled.
6	CP0OUT	Comparator0 Output State Flag. 0: Voltage on CP0+ < CP0-. 1: Voltage on CP0+ > CP0-.
5	CP0RIF	Comparator0 Rising-Edge Flag. Must be cleared by software. 0: No Comparator0 Rising Edge has occurred since this flag was last cleared. 1: Comparator0 Rising Edge has occurred.
4	CP0FIF	Comparator0 Falling-Edge Flag. Must be cleared by software. 0: No Comparator0 Falling-Edge has occurred since this flag was last cleared. 1: Comparator0 Falling-Edge has occurred.
3:2	CP0HYP[1:0]	Comparator0 Positive Hysteresis Control Bits. 00: Positive Hysteresis Disabled. 01: Positive Hysteresis = 5 mV. 10: Positive Hysteresis = 10 mV. 11: Positive Hysteresis = 20 mV.
1:0	CP0HYN[1:0]	Comparator0 Negative Hysteresis Control Bits. 00: Negative Hysteresis Disabled. 01: Negative Hysteresis = 5 mV. 10: Negative Hysteresis = 10 mV. 11: Negative Hysteresis = 20 mV.

space. The addressing mode used by an instruction when accessing locations above 0x7F determines whether the CPU accesses the upper 128 bytes of data memory space or the SFRs. Instructions that use direct addressing will access the SFR space. Instructions using indirect addressing above 0x7F access the upper 128 bytes of data memory. Figure 13.1 illustrates the data memory organization of the C8051F336/7/8/9.

13.2.1.1. General Purpose Registers

The lower 32 bytes of data memory, locations 0x00 through 0x1F, may be addressed as four banks of general-purpose registers. Each bank consists of eight byte-wide registers designated R0 through R7. Only one of these banks may be enabled at a time. Two bits in the program status word, RS0 (PSW.3) and RS1 (PSW.4), select the active register bank (see description of the PSW in SFR Definition 12.6). This allows fast context switching when entering subroutines and interrupt service routines. Indirect addressing modes use registers R0 and R1 as index registers.

13.2.1.2. Bit Addressable Locations

In addition to direct access to data memory organized as bytes, the sixteen data memory locations at 0x20 through 0x2F are also accessible as 128 individually addressable bits. Each bit has a bit address from 0x00 to 0x7F. Bit 0 of the byte at 0x20 has bit address 0x00 while bit 7 of the byte at 0x20 has bit address 0x07. Bit 7 of the byte at 0x2F has bit address 0x7F. A bit access is distinguished from a full byte access by the type of instruction used (bit source or destination operands as opposed to a byte source or destination).

The MCS-51™ assembly language allows an alternate notation for bit addressing of the form XX.B where XX is the byte address and B is the bit position within the byte. For example, the instruction:

```
MOV    C, 22.3h
moves the Boolean value at 0x13 (bit 3 of the byte at location 0x22) into the Carry flag.
```

13.2.1.3. Stack

A programmer's stack can be located anywhere in the 256-byte data memory. The stack area is designated using the Stack Pointer (SP) SFR. The SP will point to the last location used. The next value pushed on the stack is placed at SP+1 and then SP is incremented. A reset initializes the stack pointer to location 0x07. Therefore, the first value pushed on the stack is placed at location 0x08, which is also the first register (R0) of register bank 1. Thus, if more than one register bank is to be used, the SP should be initialized to a location in the data memory not being used for data storage. The stack depth can extend up to 256 bytes.

13.2.2. External RAM

There are 512 bytes of on-chip RAM mapped into the external data memory space. All of these address locations may be accessed using the external move instruction (MOVX) and the data pointer (DPTR), or using MOVX indirect addressing mode. If the MOVX instruction is used with an 8-bit address operand (such as @R1), then the high byte of the 16-bit address is provided by the External Memory Interface Control Register (EMI0CN as shown in SFR Definition 13.1). Note: the MOVX instruction is also used for writes to the Flash memory. See [Section "16. Flash Memory" on page 91](#) for details. The MOVX instruction accesses XRAM by default.

For a 16-bit MOVX operation (@DPTR), the upper 7 bits of the 16-bit external data memory address word are "don't cares". As a result, the 512-byte RAM is mapped modulo style over the entire 64 k external data memory address range. For example, the XRAM byte at address 0x0000 is shadowed at addresses 0x0200, 0x0400, 0x0600, 0x0800, etc. This is a useful feature when performing a linear memory fill, as the address pointer doesn't have to be reset when reaching the RAM block boundary.

SFR Definition 16.1. PSCTL: Program Store R/W Control

Bit	7	6	5	4	3	2	1	0
Name							PSEE	PSWE
Type	R	R	R	R	R	R	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x8F

Bit	Name	Function
7:2	UNUSED	Unused. Read = 000000b, Write = don't care.
1	PSEE	Program Store Erase Enable Setting this bit (in combination with PSWE) allows an entire page of Flash program memory to be erased. If this bit is logic 1 and Flash writes are enabled (PSWE is logic 1), a write to Flash memory using the MOVX instruction will erase the entire page that contains the location addressed by the MOVX instruction. The value of the data byte written does not matter. 0: Flash program memory erasure disabled. 1: Flash program memory erasure enabled.
0	PSWE	Program Store Write Enable Setting this bit allows writing a byte of data to the Flash program memory using the MOVX write instruction. The Flash location should be erased before writing data. 0: Writes to Flash program memory disabled. 1: Writes to Flash program memory enabled; the MOVX write instruction targets Flash memory.

17. Reset Sources

Reset circuitry allows the controller to be easily placed in a predefined default condition. Upon entering this reset state, the following events occur:

- CIP-51 halts program execution
- Special Function Registers (SFRs) are initialized to their defined reset values
- External Port pins are forced to a known state
- Interrupts and timers are disabled.

All SFRs are reset to the predefined values noted in the SFR detailed descriptions. The contents of internal data memory are unaffected during a reset; any previously stored data is preserved. However, since the stack pointer SFR is reset, the stack is effectively lost, even though the data on the stack is not altered.

The Port I/O latches are reset to 0xFF (all logic ones) in open-drain mode. Weak pullups are enabled during and after the reset. For V_{DD} Monitor and power-on resets, the RST pin is driven low until the device exits the reset state.

On exit from the reset state, the program counter (PC) is reset, and the system clock defaults to the internal oscillator. The Watchdog Timer is enabled with the system clock divided by 12 as its clock source. Program execution begins at location 0x0000.

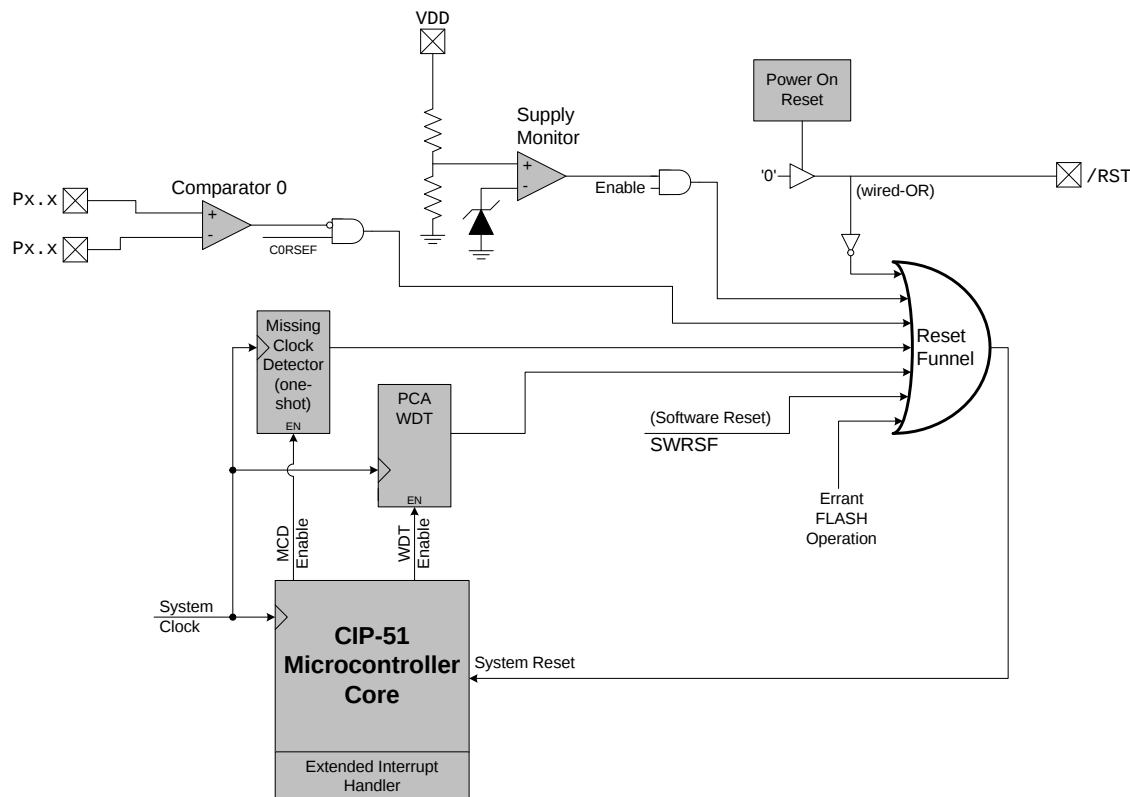


Figure 17.1. Reset Sources

SFR Definition 17.1. VDM0CN: V_{DD} Monitor Control

Bit	7	6	5	4	3	2	1	0
Name	VDMEN	VDDSTAT						
Type	R/W	R	R	R	R	R	R	R
Reset	Varies	Varies	0	0	0	0	0	0

SFR Address = 0xFF

Bit	Name	Function
7	VDMEN	V_{DD} Monitor Enable. This bit turns the V _{DD} monitor circuit on/off. The V _{DD} Monitor cannot generate system resets until it is also selected as a reset source in register RSTSRC (SFR Definition 17.2). Selecting the V _{DD} monitor as a reset source before it has stabilized may generate a system reset. In systems where this reset would be undesirable, a delay should be introduced between enabling the V _{DD} Monitor and selecting it as a reset source. 0: V _{DD} Monitor Disabled. 1: V _{DD} Monitor Enabled.
6	VDDSTAT	V_{DD} Status. This bit indicates the current power supply status (V _{DD} Monitor output). 0: V _{DD} is at or below the V _{DD} monitor threshold. 1: V _{DD} is above the V _{DD} monitor threshold.
5:0	UNUSED	Unused. Read = 000000b; Write = Don't care.

17.3. External Reset

The external $\overline{\text{RST}}$ pin provides a means for external circuitry to force the device into a reset state. Asserting an active-low signal on the $\overline{\text{RST}}$ pin generates a reset; an external pullup and/or decoupling of the $\overline{\text{RST}}$ pin may be necessary to avoid erroneous noise-induced resets. See [Section “6. Electrical Characteristics” on page 27](#) for complete $\overline{\text{RST}}$ pin specifications. The PINRSF flag (RSTSRC.0) is set on exit from an external reset.

17.4. Missing Clock Detector Reset

The Missing Clock Detector (MCD) is a one-shot circuit that is triggered by the system clock. If the system clock remains high or low for more than 100 μs , the one-shot will time out and generate a reset. After a MCD reset, the MCDRSF flag (RSTSRC.2) will read ‘1’, signifying the MCD as the reset source; otherwise, this bit reads ‘0’. Writing a ‘1’ to the MCDRSF bit enables the Missing Clock Detector; writing a ‘0’ disables it. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

19. Oscillators and Clock Selection

C8051F336/7/8/9 devices include a programmable internal high-frequency oscillator, a programmable internal low-frequency oscillator, and an external oscillator drive circuit. The internal high-frequency oscillator can be enabled/disabled and calibrated using the OSCICN and OSCICL registers, as shown in Figure 19.1. The internal low-frequency oscillator can be enabled/disabled and calibrated using the OSCLCN register. The system clock can be sourced by the external oscillator circuit or either internal oscillator. Both internal oscillators offer a selectable post-scaling feature.

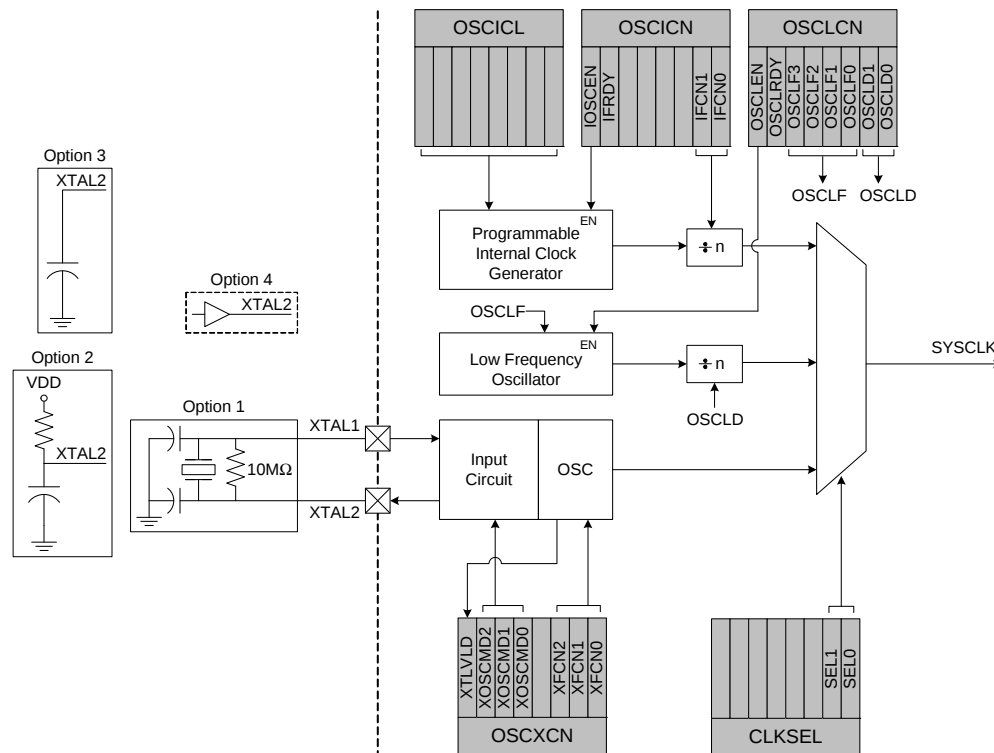


Figure 19.1. Oscillator Options

19.1. System Clock Selection

The CLKSL[1:0] bits in register CLKSEL select which oscillator source is used as the system clock. CLKSL[1:0] must be set to 01b for the system clock to run from the external oscillator; however the external oscillator may still clock certain peripherals (timers, PCA) when the internal oscillator is selected as the system clock. The system clock may be switched on-the-fly between the internal oscillator, external oscillator, and Clock Multiplier so long as the selected clock source is enabled and has settled.

The internal high-frequency and low-frequency oscillators require little start-up time and may be selected as the system clock immediately following the register write which enables the oscillator. The external RC and C modes also typically require no startup time.

External crystals and ceramic resonators however, typically require a start-up time before they are settled and ready for use. The Crystal Valid Flag (XTLVLD in register OSCXCN) is set to '1' by hardware when the external crystal or ceramic resonator is settled. **In crystal mode, to avoid reading a false XTLVLD, software should delay at least 1 ms between enabling the external oscillator and checking XTLVLD.**

20.2. Assigning Port I/O Pins to Analog and Digital Functions

Port I/O pins P0.0 - P2.3 can be assigned to various analog, digital, and external interrupt functions. The Port pins assigned to analog functions should be configured for analog I/O, and Port pins assigned to digital or external interrupt functions should be configured for digital I/O.

20.2.1. Assigning Port I/O Pins to Analog Functions

Table 20.1 shows all available analog functions that require Port I/O assignments. **Port pins selected for these analog functions should have their corresponding bit in PnSKIP set to '1'.** This reserves the pin for use by the analog function and does not allow it to be claimed by the Crossbar. Table 20.1 shows the potential mapping of Port I/O to each analog function.

Table 20.1. Port I/O Assignment for Analog Functions

Analog Function	Potentially Assignable Port Pins	SFR(s) used for Assignment
ADC Input	P0.0 - P2.3	AMX0P, AMX0N, PnSKIP, PnMDIN
Comparator0 Input	P0.0 - P2.3	CPT0MX, PnSKIP, PnMDIN
Voltage Reference (VREF0)	P0.0	REF0CN, PnSKIP, PnMDIN
Current DAC Output (IDA0)	P0.1	IDA0CN, PnSKIP, PnMDIN
External Oscillator in Crystal Mode (XTAL1)	P0.2	OSCXCN, PnSKIP, PnMDIN
External Oscillator in RC, C, or Crystal Mode (XTAL2)	P0.3	OSCXCN, PnSKIP, PnMDIN

20.2.2. Assigning Port I/O Pins to Digital Functions

Any Port pins not assigned to analog functions may be assigned to digital functions or used as GPIO. Most digital functions rely on the Crossbar for pin assignment; however, some digital functions bypass the Crossbar in a manner similar to the analog functions listed above. **Port pins used by these digital functions and any Port pins selected for use as GPIO should have their corresponding bit in PnSKIP set to '1'.** Table 20.2 shows all available digital functions and the potential mapping of Port I/O to each digital function.

Table 20.2. Port I/O Assignment for Digital Functions

Digital Function	Potentially Assignable Port Pins	SFR(s) used for Assignment
UART0, SPI0, SMBus, CP0, CP0A, SYSCLK, PCA0 (CEX0-2 and ECI), T0 or T1.	Any Port pin available for assignment by the Crossbar. This includes P0.0 - P2.3 pins which have their PnSKIP bit set to '0'. Note: The Crossbar will always assign UART0 pins to P0.4 and P0.5.	XBR0, XBR1
Any pin used for GPIO	P0.0 - P2.4	P0SKIP, P1SKIP, P2SKIP

20.3. Priority Crossbar Decoder

The Priority Crossbar Decoder (Figure 20.4) assigns a priority to each I/O function, starting at the top with UART0. When a digital resource is selected, the least-significant unassigned Port pin is assigned to that resource (excluding UART0, which is always at pins 4 and 5). If a Port pin is assigned, the Crossbar skips that pin when assigning the next selected resource. Additionally, the Crossbar will skip Port pins whose associated bits in the PnSKIP registers are set. The PnSKIP registers allow software to skip Port pins that are to be used for analog input, dedicated functions, or GPIO.

Important Note on Crossbar Configuration: If a Port pin is claimed by a peripheral without use of the Crossbar, its corresponding PnSKIP bit should be set. This applies to P0.0 if VREF is used, P0.3 and/or P0.2 if the external oscillator circuit is enabled, P0.6 if the ADC or IDAC is configured to use the external conversion start signal (CNVSTR), and any selected ADC or Comparator inputs. The Crossbar skips selected pins as if they were already assigned, and moves to the next unassigned pin.

Figure 20.4 shows all of the potential peripheral-to-pin assignments available to the crossbar. Note that this does not mean any peripheral can always be assigned to the highlighted pins. The actual pin assignments are determined by the priority of the enabled peripherals.

	P0								P1								P2				
SF Signals	VREF	IDA	x1	x2	CNVSTR																
PIN I/O	0	1	2	3	4	5	6	7	0	1	2	3	4	5	6	7	0	1 ²	2 ²	3 ²	4 ²
TX0																					
RX0																					
SCK																					
MISO																					
MOSI																					
NSS ¹																					
SDA																					
SCL																					
CP0																					
CP0A																					
SYSCLK																					
CEX0																					
CEX1																					
CEX2																					
ECI																					
T0																					
T1																					

Pin not available for crossbar peripherals.



Port pin potentially available to peripheral

SF Signals

Special Function Signals are not assigned by the crossbar. When these signals are enabled, the Crossbar must be manually configured to skip their corresponding port pins.

Notes:

1. NSS is only pinned out in 4-wire SPI Mode
2. Pins P2.1-P2.4 only on QFN24 Package
3. Pin 2.0 unavailable on crossbar in QFN20 Package

Figure 20.4. Crossbar Priority Decoder - Possible Pin Assignments

20.4. Port I/O Initialization

Port I/O initialization consists of the following steps:

1. Select the input mode (analog or digital) for all Port pins, using the Port Input Mode register (PnMDIN).
2. Select the output mode (open-drain or push-pull) for all Port pins, using the Port Output Mode register (PnMDOUT).
3. Select any pins to be skipped by the I/O Crossbar using the Port Skip registers (PnSKIP).
4. Assign Port pins to desired peripherals.
5. Enable the Crossbar (XBARE = '1').

All Port pins must be configured as either analog or digital inputs. Any pins to be used as Comparator or ADC inputs should be configured as analog inputs. When a pin is configured as an analog input, its weak pullup, digital driver, and digital receiver are disabled. This process saves power and reduces noise on the analog input. Pins configured as digital inputs may still be used by analog peripherals; however this practice is not recommended.

Additionally, all analog input pins should be configured to be skipped by the Crossbar (accomplished by setting the associated bits in PnSKIP). Port input mode is set in the PnMDIN register, where a '1' indicates a digital input, and a '0' indicates an analog input. All pins default to digital inputs on reset. See SFR Definition 20.8 for the PnMDIN register details.

The output driver characteristics of the I/O pins are defined using the Port Output Mode registers (PnMDOUT). Each Port Output driver can be configured as either open drain or push-pull. This selection is required even for the digital resources selected in the XBRn registers, and is not automatic. The only exception to this is the SMBus (SDA, SCL) pins, which are configured as open-drain regardless of the PnMDOUT settings. When the WEAKPUD bit in XBR1 is '0', a weak pullup is enabled for all Port I/O configured as open-drain. WEAKPUD does not affect the push-pull Port I/O. Furthermore, the weak pullup is turned off on an output that is driving a '0' to avoid unnecessary power dissipation.

Registers XBR0 and XBR1 must be loaded with the appropriate values to select the digital I/O functions required by the design. Setting the XBARE bit in XBR1 to '1' enables the Crossbar. Until the Crossbar is enabled, the external pins remain as standard Port I/O (in input mode), regardless of the XBRn Register settings. For given XBRn Register settings, one can determine the I/O pin-out using the Priority Decode Table; as an alternative, the Configuration Wizard utility of the Silicon Labs IDE software will determine the Port I/O pin-assignments based on the XBRn Register settings.

The Crossbar must be enabled to use Port pins as standard Port I/O in output mode. Port output drivers are disabled while the Crossbar is disabled.

SFR Definition 20.9. P0MDOUT: Port 0 Output Mode

Bit	7	6	5	4	3	2	1	0
Name	P0MDOUT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xA4

Bit	Name	Function
7:0	P0MDOUT[7:0]	Output Configuration Bits for P0.7–P0.0 (respectively). These bits are ignored if the corresponding bit in register P0MDIN is logic 0. 0: Corresponding P0.n Output is open-drain. 1: Corresponding P0.n Output is push-pull.

SFR Definition 20.10. P0SKIP: Port 0 Skip

Bit	7	6	5	4	3	2	1	0
Name	P0SKIP[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD4

Bit	Name	Function
7:0	P0SKIP[7:0]	Port 0 Crossbar Skip Enable Bits. These bits select Port 0 pins to be skipped by the Crossbar Decoder. Port pins used for analog, special functions or GPIO should be skipped by the Crossbar. 0: Corresponding P0.n pin is not skipped by the Crossbar. 1: Corresponding P0.n pin is skipped by the Crossbar.

21.1. Supporting Documents

It is assumed the reader is familiar with or has access to the following supporting documents:

1. The I²C-Bus and How to Use It (including specifications), Philips Semiconductor.
2. The I²C-Bus Specification—Version 2.0, Philips Semiconductor.
3. System Management Bus Specification—Version 1.1, SBS Implementers Forum.

21.2. SMBus Configuration

Figure 21.2 shows a typical SMBus configuration. The SMBus specification allows any recessive voltage between 3.0 V and 5.0 V; different devices on the bus may operate at different voltage levels. The bi-directional SCL (serial clock) and SDA (serial data) lines must be connected to a positive power supply voltage through a pullup resistor or similar circuit. Every device connected to the bus must have an open-drain or open-collector output for both the SCL and SDA lines, so that both are pulled high (recessive state) when the bus is free. The maximum number of devices on the bus is limited only by the requirement that the rise and fall times on the bus not exceed 300 ns and 1000 ns, respectively.

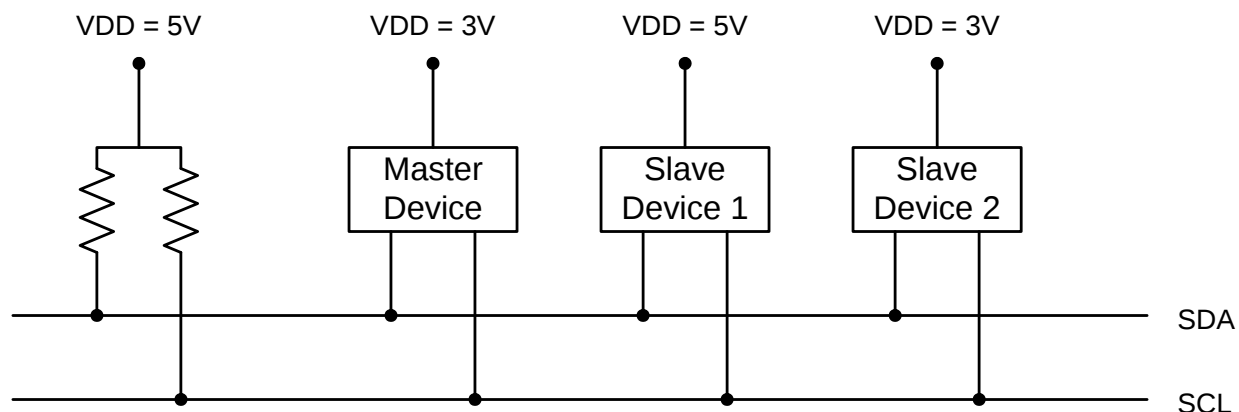


Figure 21.2. Typical SMBus Configuration

21.3. SMBus Operation

Two types of data transfers are possible: data transfers from a master transmitter to an addressed slave receiver (WRITE), and data transfers from an addressed slave transmitter to a master receiver (READ). The master device initiates both types of data transfers and provides the serial clock pulses on SCL. The SMBus interface may operate as a master or a slave, and multiple master devices on the same bus are supported. If two or more masters attempt to initiate a data transfer simultaneously, an arbitration scheme is employed with a single master always winning the arbitration. Note that it is not necessary to specify one device as the Master in a system; any device who transmits a START and a slave address becomes the master for the duration of that transfer.

A typical SMBus transaction consists of a START condition followed by an address byte (Bits7–1: 7-bit slave address; Bit0: R/W direction bit), one or more bytes of data, and a STOP condition. Bytes that are received (by a master or slave) are acknowledged (ACK) with a low SDA during a high SCL (see Figure 21.3). If the receiving device does not ACK, the transmitting device will read a NACK (not acknowledge), which is a high SDA during a high SCL.

The direction bit (R/W) occupies the least-significant bit position of the address byte. The direction bit is set to logic 1 to indicate a "READ" operation and cleared to logic 0 to indicate a "WRITE" operation.

Table 21.6. SMBus Status Decoding With Hardware ACK Generation Enabled (EHACK = 1) (Continued)

Mode	Values Read			Current SMBus State	Typical Response Options	Values to Write			Next Status Vector Expected
	Status Vector	ACKRQ	ARBLOST	ACK		STA	STO	ACK	
Slave Transmitter	0100	0	0	0	A slave byte was transmitted; NACK received.	0	0	X	0001
		0	0	1	A slave byte was transmitted; ACK received.	0	0	X	0100
		0	1	X	A Slave byte was transmitted; error detected.	0	0	X	0001
	0101	0	X	X	An illegal STOP or bus error was detected while a Slave Transmission was in progress.	0	0	X	—
Slave Receiver	0010	0	0	X	A slave address + R/W was received; ACK sent.	0	0	1	0000
					If Read, Load SMB0DAT with data byte	0	0	X	0100
		0	1	X	Lost arbitration as master; slave address + R/W received; ACK sent.	0	0	1	0000
					If Read, Load SMB0DAT with data byte	0	0	X	0100
					Reschedule failed transfer	1	0	X	1110
	0001	0	0	X	A STOP was detected while addressed as a Slave Transmitter or Slave Receiver.	0	0	X	—
		0	1	X	Lost arbitration while attempting a STOP.	0	0	0	—
	0000	0	0	X	A slave byte was received.	0	0	1	0000
					Set NACK for next data byte; Read SMB0DAT.	0	0	0	0000
Bus Error Condition	0010	0	1	X	Lost arbitration while attempting a repeated START.	0	0	X	—
					Reschedule failed transfer.	1	0	X	1110
	0001	0	1	X	Lost arbitration due to a detected STOP.	0	0	X	—
					Reschedule failed transfer.	1	0	X	1110
	0000	0	1	X	Lost arbitration while transmitting a data byte as master.	0	0	X	—
					Reschedule failed transfer.	1	0	X	1110

SFR Definition 23.3. SPI0CKR: SPI0 Clock Rate

Bit	7	6	5	4	3	2	1	0
Name	SCR[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xA2

Bit	Name	Function
7:0	SCR[7:0]	SPI0 Clock Rate. These bits determine the frequency of the SCK output when the SPI0 module is configured for master mode operation. The SCK clock frequency is a divided version of the system clock, and is given in the following equation, where <i>SYSCLK</i> is the system clock frequency and <i>SPI0CKR</i> is the 8-bit value held in the SPI0CKR register. $f_{SCK} = \frac{SYSCLK}{2 \times (SPI0CKR[7:0] + 1)}$ for $0 \leq SPI0CKR \leq 255$ Example: If <i>SYSCLK</i> = 2 MHz and <i>SPI0CKR</i> = 0x04, $f_{SCK} = \frac{2000000}{2 \times (4 + 1)}$ $f_{SCK} = 200kHz$

SFR Definition 23.4. SPI0DAT: SPI0 Data

Bit	7	6	5	4	3	2	1	0
Name	SPI0DAT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xA3

Bit	Name	Function
7:0	SPI0DAT[7:0]	SPI0 Transmit and Receive Data. The SPI0DAT register is used to transmit and receive SPI0 data. Writing data to SPI0DAT places the data into the transmit buffer and initiates a transfer when in Master Mode. A read of SPI0DAT returns the contents of the receive buffer.

SFR Definition 24.1. CKCON: Clock Control

Bit	7	6	5	4	3	2	1	0
Name	T3MH	T3ML	T2MH	T2ML	T1M	T0M	SCA[1:0]	
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x8E

Bit	Name	Function
7	T3MH	Timer 3 High Byte Clock Select. Selects the clock supplied to the Timer 3 high byte (split 8-bit timer mode only). 0: Timer 3 high byte uses the clock defined by the T3XCLK bit in TMR3CN. 1: Timer 3 high byte uses the system clock.
6	T3ML	Timer 3 Low Byte Clock Select. Selects the clock supplied to Timer 3. Selects the clock supplied to the lower 8-bit timer in split 8-bit timer mode. 0: Timer 3 low byte uses the clock defined by the T3XCLK bit in TMR3CN. 1: Timer 3 low byte uses the system clock.
5	T2MH	Timer 2 High Byte Clock Select. Selects the clock supplied to the Timer 2 high byte (split 8-bit timer mode only). 0: Timer 2 high byte uses the clock defined by the T2XCLK bit in TMR2CN. 1: Timer 2 high byte uses the system clock.
4	T2ML	Timer 2 Low Byte Clock Select. Selects the clock supplied to Timer 2. If Timer 2 is configured in split 8-bit timer mode, this bit selects the clock supplied to the lower 8-bit timer. 0: Timer 2 low byte uses the clock defined by the T2XCLK bit in TMR2CN. 1: Timer 2 low byte uses the system clock.
3	T1	Timer 1 Clock Select. Selects the clock source supplied to Timer 1. Ignored when C/T1 is set to '1'. 0: Timer 1 uses the clock defined by the prescale bits SCA[1:0]. 1: Timer 1 uses the system clock.
2	T0	Timer 0 Clock Select. Selects the clock source supplied to Timer 0. Ignored when C/T0 is set to '1'. 0: Counter/Timer 0 uses the clock defined by the prescale bits SCA[1:0]. 1: Counter/Timer 0 uses the system clock.
1:0	SCA[1:0]	Timer 0/1 Prescale Bits. These bits control the Timer 0/1 Clock Prescaler: 00: System clock divided by 12 01: System clock divided by 4 10: System clock divided by 48 11: External clock divided by 8 (synchronized with the system clock)

24.3.2. 8-bit Timers with Auto-Reload

When T3SPLIT is set, Timer 3 operates as two 8-bit timers (TMR3H and TMR3L). Both 8-bit timers operate in auto-reload mode as shown in Figure 24.8. TMR3RLL holds the reload value for TMR3L; TMR3RLH holds the reload value for TMR3H. The TR3 bit in TMR3CN handles the run control for TMR3H. TMR3L is always running when configured for 8-bit Mode.

Each 8-bit timer may be configured to use SYSCLK, SYSCLK divided by 12, the external oscillator clock source divided by 8, or the internal Low-frequency Oscillator. The Timer 3 Clock Select bits (T3MH and T3ML in CKCON) select either SYSCLK or the clock defined by the Timer 3 External Clock Select bits (T3XCLK[1:0] in TMR3CN), as follows:

T3MH	T3XCLK[1:0]	TMR3H Clock Source
0	00	SYSCLK / 12
0	01	External Clock / 8
0	10	Reserved
0	11	Internal LFO
1	X	SYSCLK

T3ML	T3XCLK[1:0]	TMR3L Clock Source
0	00	SYSCLK / 12
0	01	External Clock / 8
0	10	Reserved
0	11	Internal LFO
1	X	SYSCLK

The TF3H bit is set when TMR3H overflows from 0xFF to 0x00; the TF3L bit is set when TMR3L overflows from 0xFF to 0x00. When Timer 3 interrupts are enabled, an interrupt is generated each time TMR3H overflows. If Timer 3 interrupts are enabled and TF3LEN (TMR3CN.5) is set, an interrupt is generated each time either TMR3L or TMR3H overflows. When TF3LEN is enabled, software must check the TF3H and TF3L flags to determine the source of the Timer 3 interrupt. The TF3H and TF3L interrupt flags are not cleared by hardware and must be manually cleared by software.

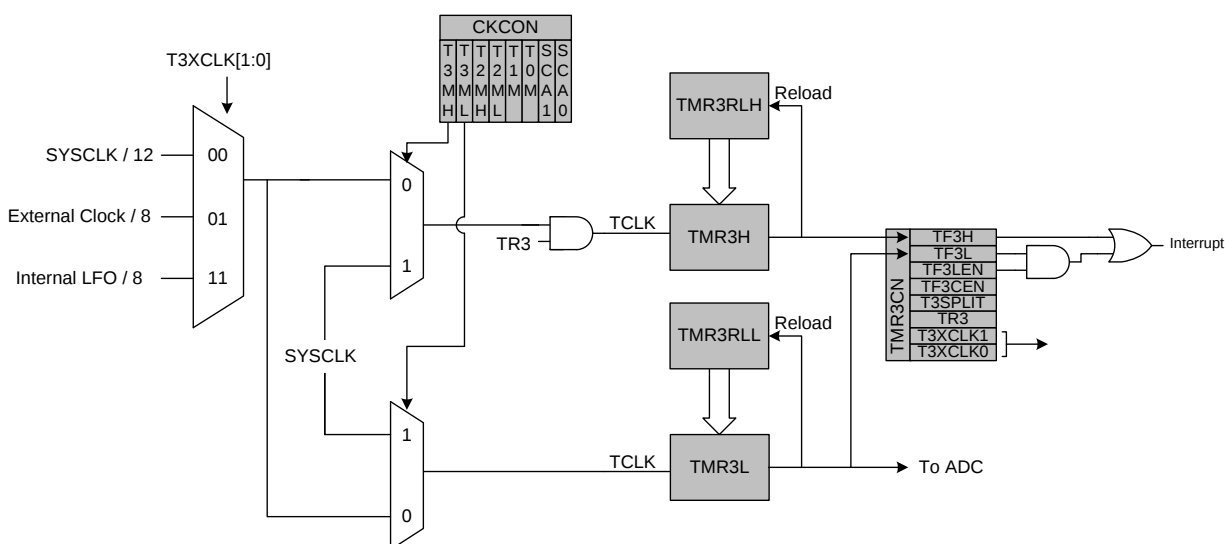


Figure 24.8. Timer 3 8-Bit Mode Block Diagram